What is claimed is:

- 1. A glue board and packaging assembly comprising:
 - a first substrate;
 - a first adhesive layer deposited on said first substrate;
- a release member with said release member overlying said first adhesive layer;
 - a second substrate:
- a second adhesive layer with said second adhesive layer in contact with said release member.
- 2. The glue board and packaging assembly as claimed in Claim 1 in which said release member comprises a first surface and a second surface with said first surface in contact with said first adhesive layer and with said second surface in contact with said second adhesive layer.
- 3. The glue board and packaging assembly as claimed in Claim 2 in which said release member comprises a thin flexible member, a first release coating deposited on said first surface, and a second release coating deposited on said second surface.
- 4. The glue board and packaging assembly as claimed in Claim 3 wherein said thin flexible member comprises a paper member.
- 5. The glue board and packaging assembly as claimed in Claim 3 wherein said thin flexible member comprises a plastic member.
- 6. The glue board and packaging assembly as claimed in Claim 3 wherein said first release coating and said second release coating comprise a fluorosilicone release coating.

- 7. The glue board and packaging assembly as claimed in Claim 1 wherein said first substrate and said second substrate each comprise a generally rectangular manner having a first and second relatively layer edge and a first and a second relatively shorter edge.
- 8. The glue board and packaging assembly as claimed in Claim 7 in which said first substrate and said second substrate further comprise a plurality of score lines with each of said score lines extending between said first and said second relatively longer edge.
- 9. The glue board and packaging assembly as claimed in Claim 1 wherein said first substrate and said second substrate are made of cardboard.
- 10. The glue board and packaging assembly as claimed in Claim 1 wherein said first substrate and said second substrate are made of paper board.
- 11. The glue board and packaging assembly as claimed in Claim 7 wherein said first relatively shorter edge comprises a tab portion.
- 12. The glue board and packaging assembly as claimed in Claim 7 wherein said first substrate and said second substrate further comprise an area adjacent to said second relatively shorter edge, and a slot formed in said area adjacent to said relatively shorter edge.
- The glue board and packaging assembly as claimed in Claim 7 wherein said first and said second substrates each further comprise:

an area adjacent said first relatively longer edge; an area adjacent said second relatively longer edge; an area adjacent said first relatively shorter edge; an area adjacent said second relatively shorter edge with said areas adjacent said relatively longer and said relatively shorter edges free of said adhesive layers.

- 14. A glue board and packaging assembly as claimed in Claim 1 in which said first substrate and said second substrate each comprise a first surface and a second surface with indicia formed on said first surface and on said second surface.
- 15. A glue board and packaging assembly as claimed in Claim 1 wherein said release member is generally coextensive with said first substrate and said second substrate, and wherein said release member facilitates peeling said first and said second substrates apart.
- 16. A method for preparing a glue board and packaging assembly comprising the steps of:

preparing a first substrate;

coating said first substrate with a first adhesive layer;

preparing a release member with said release member having a first surface and a second surface;

placing said release member overlying said first adhesive layer with said first surface of said release member contracting said first adhesive layer;

coating said second substrate with a second adhesive layer and placing said second substrate overlying said release member with said second surface of said release member in contact with said second adhesive layer.